# **74LVC544A**

# Octal D-type registered transceiver; inverting; 3-state Rev. 4 — 18 December 2012 Product of

**Product data sheet** 

#### **General description** 1.

The 74LVC544A is an octal registered inverting transceiver containing two sets of D-type latches for temporary storage of the data flow in either direction. Separate latch enable inputs (LEAB and LEBA) and output enable inputs (OEAB and OEBA) are provided for each register to permit independent control of input and output in either direction of the data flow.

The 74LVC544A contains eight D-type latches, with separate inputs and controls for each set. For data flow from pins A to B, for example, the A to B enable input (pin EAB) must be LOW in order to enter data from pins A0 to A7 or take data from pins B0 to B7. With pin EAB LOW, a LOW signal on the A to B latch enable input (pin LEAB) makes the A to B latches transparent; a subsequent LOW-to-HIGH transition on pin LEAB puts the A data into the latches where it is stored and the B outputs no longer change with the A inputs. With pins EAB and OEAB both LOW, the 3-state B output buffers are active and display the data present at the outputs of the A latches.

#### Features and benefits 2.

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low-power consumption
- Direct interface with TTL levels
- 8-bit octal transceiver with D-type latch
- Back-to-back registers for storage
- Separate controls for data flow in each direction
- Supports partial power-down applications; inputs/outputs are high-impedance when  $V_{CC} = 0 V$
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



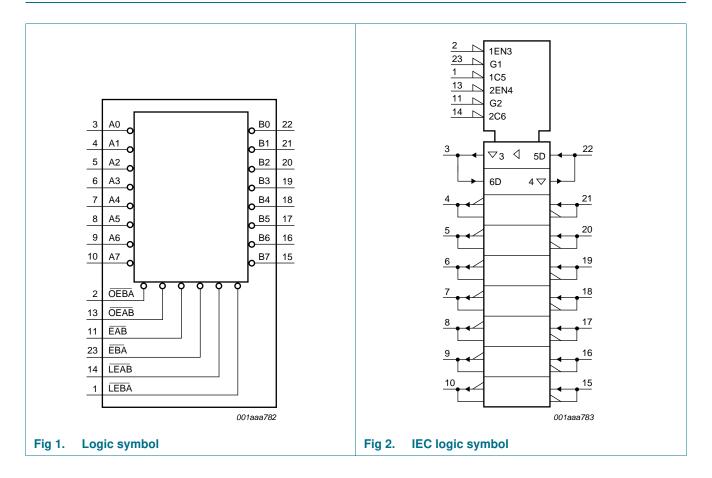
# Octal D-type registered transceiver; inverting; 3-state

# 3. Ordering information

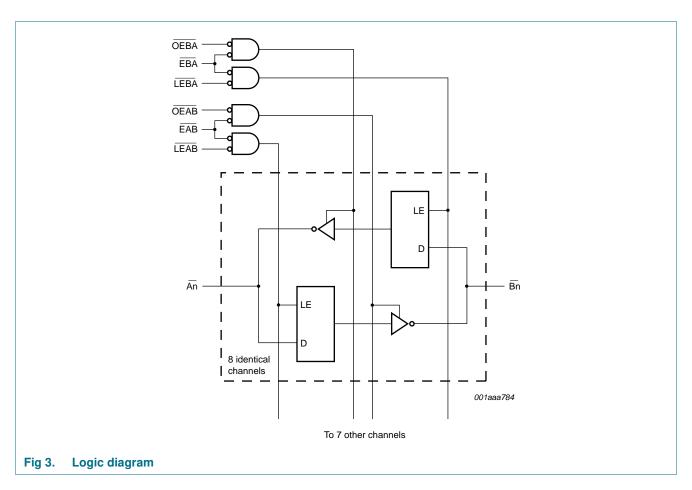
Table 1. Ordering information

Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC544AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1						
74LVC544ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1						
74LVC544APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1						

# 4. Functional diagram

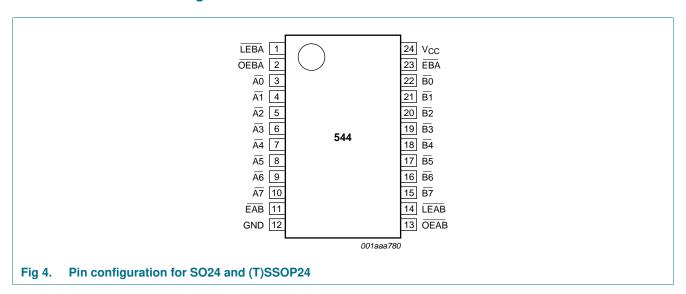


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# 5. Pinning information

# 5.1 Pinning



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# 5.2 Pin description

Table 2. Pin description

	• -	
Symbol	Pin	Description
LEBA	1	B to A latch enable input (active LOW)
OEBA	2	B to A output enable input (active LOW)
<del>A0</del>	3	A data input or output
A1	4	A data input or output
A2	5	A data input or output
<del>A3</del>	6	A data input or output
<del>A4</del>	7	A data input or output
A5	8	A data input or output
<del>A6</del>	9	A data input or output
<del>A7</del>	10	A data input or output
EAB	11	A to B enable input (active LOW)
GND	12	ground (0 V)
OEAB	13	A to B output enable input (active LOW)
LEAB	14	A to B latch enable input (active LOW)
B7	15	B data output or input
B6	16	B data output or input
B5	17	B data output or input
B4	18	B data output or input
B3	19	B data output or input
B2	20	B data output or input
B1	21	B data output or input
B0	22	B data output or input
EBA	23	B to A enable input (active LOW)
V <sub>CC</sub>	24	supply voltage

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# 6. Functional description

Table 3. Function table[1]

Operating mode	Input	Output			
	OEAB, OEBA	EAB, EBA	LEAB, LEBA	An, Bn	Bn, An
Disabled	Н	X	X	X	Z
	Χ	Н	Χ	Х	Z
Disabled plus latch	L	<b>↑</b>	L	h	Z
	L	<b>↑</b>	L	I	Z
Latch plus display	L	L	<b>↑</b>	h	L
	L	L	<b>↑</b>	I	Н
Transparent	L	L	L	Н	L
	L	L	L	L	Н
Hold (do nothing)	L	L	Н	Χ	NC

<sup>[1]</sup> XX = AB for A to B direction and BA for B to A direction

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	$V_I < 0 V$	-50	-	mA
$V_{I}$	input voltage		[ <u>1]</u> -0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
V <sub>O</sub>	output voltage	output HIGH or LOW state	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	<u>[3]</u> _	500	mW

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

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H = HIGH voltage level

L = LOW voltage level

h = HIGH state must be present one set-up time before the LOW-to-HIGH transition of  $\overline{LEAB}$ ,  $\overline{LEBA}$ ,  $\overline{EAB}$  and  $\overline{EBA}$ 

I = LOW state must be present one set-up time before the LOW-to-HIGH transition of  $\overline{LEAB}$ ,  $\overline{LEBA}$ ,  $\overline{EAB}$  and  $\overline{EBA}$ 

X = don't care

<sup>↑ =</sup> LOW to HIGH level transition

NC = no change

Z = high-impedance OFF-state

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> For SO24 packages: above 70 °C the value of P<sub>tot</sub> derates linearly with 8 mW/K. For (T)SSOP24 packages: above 60 °C the value of P<sub>tot</sub> derates linearly with 5.5 mW/K.

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# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
V <sub>I</sub>	input voltage		0	-	5.5	V
V <sub>O</sub>	output voltage	output HIGH or LOW state	0	-	$V_{CC}$	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC}$ = 2.7 V to 3.6 V	0	-	10	ns/V

# 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	85 °C	-40 °C to	+125 °C	Unit
			Min	Typ[1]	Max	Min	Max	1
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
$V_{OH}$	HIGH-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \ to \ 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	8.0	V
I <sub>I</sub>	input leakage current	$V_{CC} = 3.6 \text{ V};$ $V_{I} = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μА

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

	•	· ·			10	,			
Symbol	Parameter	Conditions		-40	°C to +85	°C	–40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
l <sub>OZ</sub>	OFF-state output current	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 3.6 \text{ V};$ $V_{O} = 5.5 \text{ V or GND};$	1	-	0.1	±10	-	±20	μΑ
l <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$		-	0.1	±10	-	±20	μА
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V};$ $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$		-	0.1	10	-	40	μА
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$		-	5	500	-	5000	μА
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$		-	5.0	-	-	-	pF
C <sub>I/O</sub>	input/output capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$		-	4.0	-	-	-	pF

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V (unless stated otherwise) and  $T_{amb}$  = 25 °C.

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			-40 °C to +125 °C	
			Min	Typ[1]	Max	Min	Max	
$t_{pd}$	propagation	An to Bn; Bn to An; see Figure 5	l					
	delay	$V_{CC} = 1.2 \text{ V}$	-	17	-	-	-	ns
	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.0	7.4	14.9	1.0	17.1	ns	
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	3.9	7.8	1.0	9.0	ns	
	$V_{CC} = 2.7 \text{ V}$	1.5	3.9	7.5	1.5	9.5	ns	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	3.3	6.5	1.0	8.5	ns
		LEBA to An; LEAB to Bn; see Figure 6						
		V <sub>CC</sub> = 1.2 V	-	19	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.5	7.5	17.5	1.5	20.2	ns
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.0	3.9	9.0	1.0	10.4	ns	
		$V_{CC} = 2.7 \text{ V}$	1.5	4.3	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.0	3.3	7.5	1.0	9.5	ns

<sup>[2]</sup> For I/O ports the parameter  $I_{OZ}$  includes the input leakage current.

# Octal D-type registered transceiver; inverting; 3-state

**Table 7. Dynamic characteristics** ...continued Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 9</u>.

Symbol	Parameter	Conditions		-40	°C to +85	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>en</sub>	enable time	OEBA to An; OEAB to Bn; see Figure 8	[2]						
		$V_{CC} = 1.2 V$		-	18	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.7	7.5	19.4	1.7	22.4	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.5	4.2	10.7	1.5	12.3	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.3	9.5	1.5	12.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.4	8.5	1.0	11.0	ns
		EBA to An; EAB to Bn; see Figure 8							
		V <sub>CC</sub> = 1.2 V		-	20	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.9	8.1	20.4	1.9	23.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	4.5	11.2	1.5	12.9	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.6	9.9	1.5	12.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.6	8.9	1.0	11.5	ns
·dis	disable time	OEBA to An; OEAB to Bn; see Figure 8	[2]						
		V <sub>CC</sub> = 1.2 V		-	8.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		2.8	5.0	11.2	2.8	13.0	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.8	6.4	1.0	7.4	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.6	7.5	1.5	9.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.3	6.5	1.0	8.5	ns
		EBA to An; EAB to Bn; see Figure 8							
		V <sub>CC</sub> = 1.2 V		-	9.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		3.0	5.1	12.0	3.0	13.8	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		1.0	2.9	6.8	1.0	7.9	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.7	7.9	1.5	10.0	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.4	6.9	1.0	9.0	ns
W	pulse width	LEXX LOW; see Figure 6							
		V <sub>CC</sub> = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.0	-	-	3.0	-	ns
		V <sub>CC</sub> = 2.7 V		2.0	-	-	2.0	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.0	0.9	-	2.0	-	ns
su	set-up time	An, Bn to LEXX, EXX; see Figure 7							
		V <sub>CC</sub> = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		V <sub>CC</sub> = 2.7 V		2.0	-	-	2.0	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		2.0	-0.5	-	2.0	-	ns
h	hold time	An, Bn to LEXX, EXX; see Figure 7							
	-	V <sub>CC</sub> = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		V <sub>CC</sub> = 2.3 V to 2.7 V		2.5	-	-	2.5	-	ns
		V <sub>CC</sub> = 2.7 V		1.0	-	_	1.0	-	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		3.0	1.5		3.0		ns

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#### Octal D-type registered transceiver; inverting; 3-state

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	-40 °C to +85 °C			-40 °C to +125 °C		
				Min	Typ[1]	Max	Min	Max		
$t_{\text{sk(o)}}$	output skew time	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns	
$C_{PD}$	power dissipation capacitance	$V_I = GND$ to $V_{CC}$	[4]							
		V <sub>CC</sub> = 1.65 V to 1.95 V		-	8.1	-	-	-	pF	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	11.8	-	-	-	pF	
		V <sub>CC</sub> = 3.0 V to 3.6 V		-	15.1	-	-	-	pF	

- [1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
  - $t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .
  - $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$$
 where:

f<sub>i</sub> = input frequency in MHz; f<sub>o</sub> = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs}$ 

#### 11. Waveforms

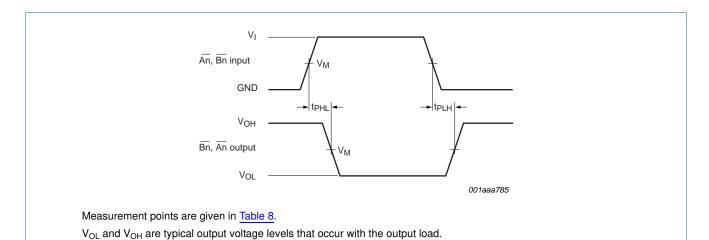
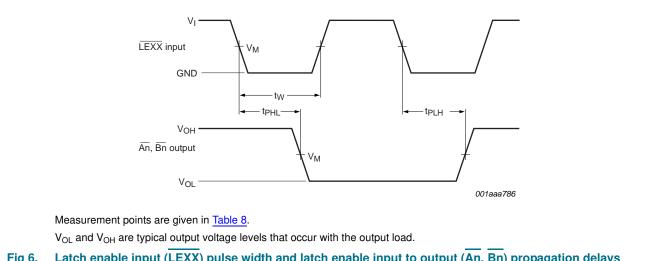


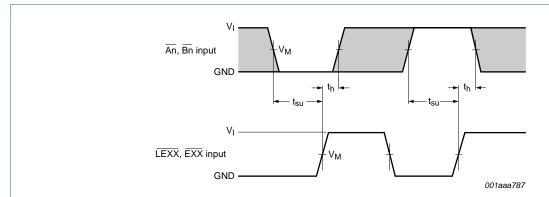
Fig 5. Input (An, Bn) to output (Bn, An) propagation delays

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Latch enable input (LEXX) pulse width and latch enable input to output (An, Bn) propagation delays Fig 6.



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance

Data set-up and hold times for the inputs (An, Bn) to LEXX and EXX inputs Fig 7.

# Octal D-type registered transceiver; inverting; 3-state

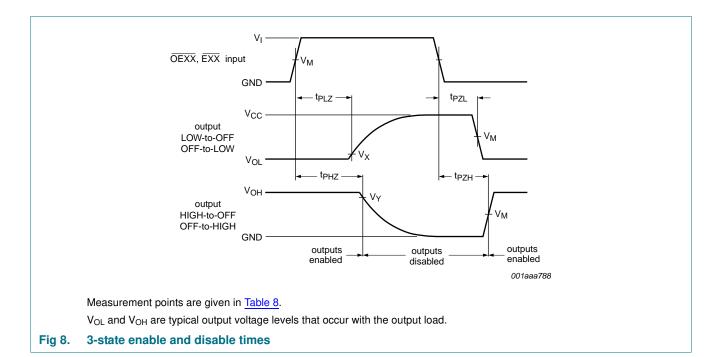
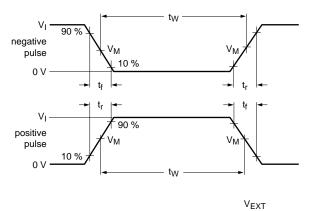
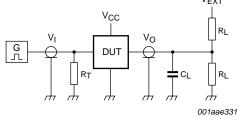


Table 8. Measurement points

Supply voltage	Input		Output					
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
1.2 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$			
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH}-0.3\ V$			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	$V_{OL} + 0.3 V$	$V_{OH}-0.3\ V$			

# Octal D-type registered transceiver; inverting; 3-state





Test data is given in Table 9.

Definitions for test circuit:

 $R_L$  = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 9. Load circuitry for switching times

Table 9. Test data

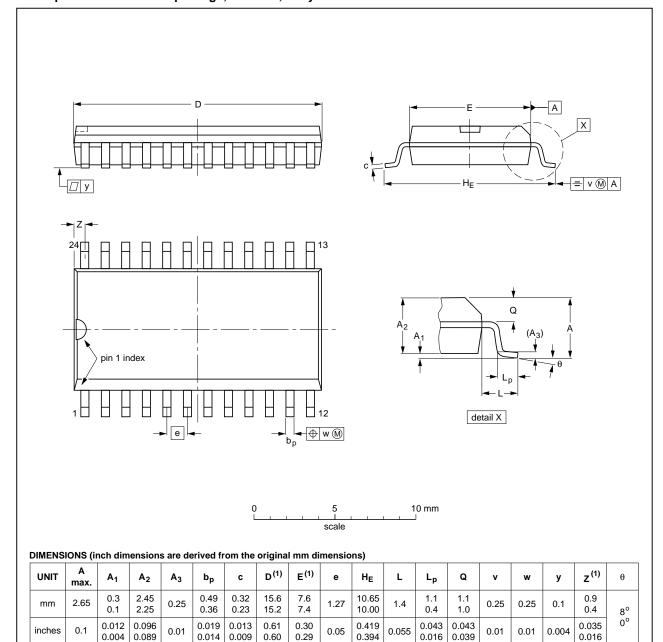
Supply voltage	Input		Load	Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	$t_{PLH}$ , $t_{PHL}$	$t_{PLZ}$ , $t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>	
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500\Omega$	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND	

#### Octal D-type registered transceiver; inverting; 3-state

# 12. Package outline

#### SO24: plastic small outline package; 24 leads; body width 7.5 mm

SOT137-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT137-1	075E05	MS-013			<del>99-12-27</del> 03-02-19

Fig 10. Package outline SOT137-1 (SO24)

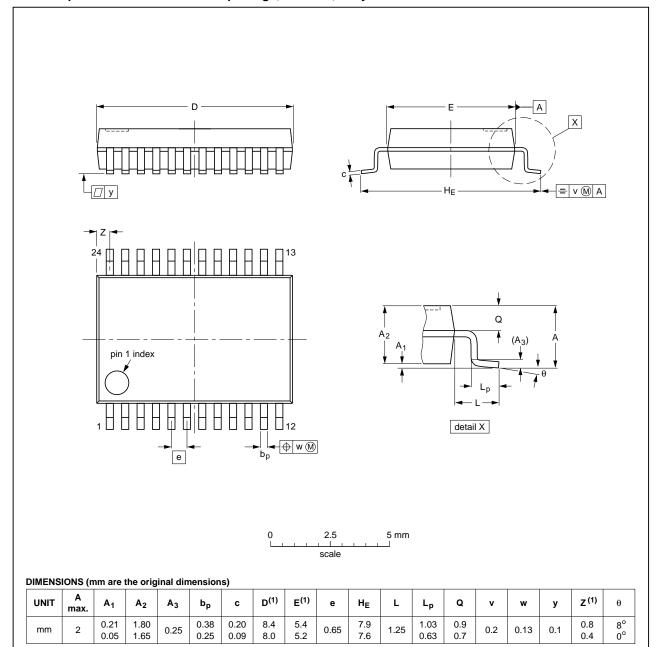
74LVC544

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SSOP24: plastic shrink small outline package; 24 leads; body width 5.3 mm

SOT340-1



#### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	ENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE
SOT340-1		MO-150			<del>99-12-27</del> 03-02-19

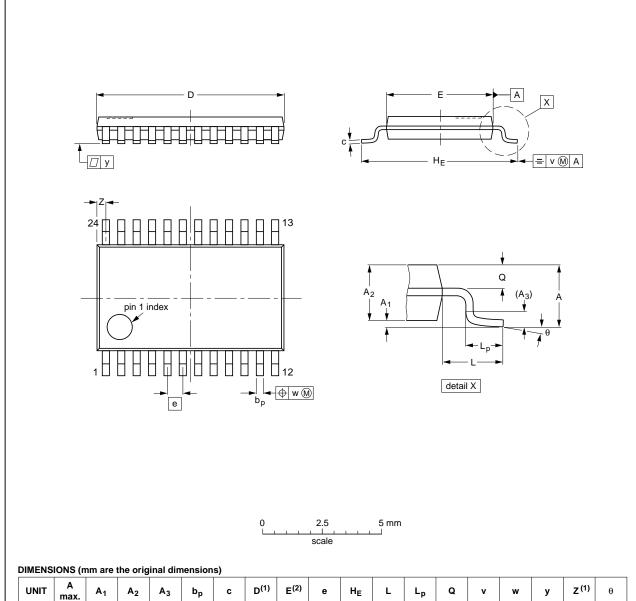
Fig 11. Package outline SOT340-1 (SSOP24)

74LVC544A

74LVC544A **NXP Semiconductors** 

TSSOP24: plastic thin shrink small outline package; 24 leads; body width 4.4 mm

SOT355-1



					,		-,												
,	UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
	mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	7.9 7.7	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE			REFER	EUROPEAN	ISSUE DATE			
	VERSION	IEC	JEDEC	JEITA		PROJECTION	1330E DATE	
	SOT355-1		MO-153				<del>-99-12-27</del> 03-02-19	

Fig 12. Package outline SOT355-1 (TSSOP24)

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# 13. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### Table 11. Revision history

	•			
Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC544A v.4	20121218	Product data sheet	-	74LVC544A v.3
Modifications:	<ul> <li>The format of of NXP Semice</li> </ul>	this data sheet has been red conductors.	esigned to comply with	the new identity guidelines
	<ul> <li>Legal texts ha</li> </ul>	ave been adapted to the new	company name where	appropriate.
	• Table 4, Table	<u>5, Table 6, Table 7, Table 8</u> a	nd <u>Table 9</u> : values add	led for lower voltage ranges.
74LVC544A v.3	20040511	Product specification	-	74LVC544A v.2
74LVC544A v.2	19980729	Product specification	-	74LVC544A v.1
74LVC544A v.1	19981110	Product specification	-	-

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# 15. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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